Amendments to the Claims

This listing of claims will replace all prior versions, and listing, of claims in the application.

Listing of Claims:

- Claim 1. (currently amended) A photoresist comprising a photoactive component and a polymer that comprises: i) a heteroalicyclic group that does not contain a carbonyl ring member and is not an oxynorbornyl anhydride or lactone and is fused to the polymer backbone and that contains one or more oxygen or sulfur ring atoms; ii) a carbon alicyclic group fused to the polymer backbone; and iii) a photoacid-labile moiety.
- Claim 2. (original) The photoresist of claim 1 wherein the heteroalicyclic group has an oxygen ring member.
- Claim 3. (original) The photoresist of claim 1 wherein the heteroalicyclic group has a sulfur ring member.
- Claim 4. (previously presented) The photoresist of claim 1 wherein the carbon alicyclic group is a polymerized norbornene group.
- Claim 5. (previously presented) The photoresist of claim 1 wherein the heteroalicyclic group has a non-hydrogen ring substituent.
 - Claims 6-7. (cancelled)
- Claim 8. (previously presented) The photoresist of claim 1 wherein the polymer comprises a polymerized acrylate that comprises a photoacid-labile group.

Claims 9-22. (cancelled)

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Claim 23. (previously presented) The photoresist of claim 1 wherein the polymer is a tetrapolymer or pentapolymer.

Claim 24. (previously presented) The photoresist of claim 1 wherein the polymer is completely free of aromatic groups.

Claims 25-34. (cancelled)

Claim 35. (previously presented) A method of forming a positive photoresist relief image, comprising:

- (a) applying a coating layer of a photoresist of claim 1 on a substrate; and
- (b) exposing and developing the photoresist image to yield a relief image.

Claims 36-40. (cancelled)

Claim 41. (previously presented) An article of manufacture comprising a microelectronic wafer substrate or a flat panel display substrate having coated thereon a layer of a photoresist composition of claim 1.

Claims 42-45. (cancelled)

Claim 46. (previously presented) The photoresist of claim 1 wherein the photoacid-labile moiety is a substituent of the heteroalicyclic group or carbon alicyclic group.

Claim 47. (currently amended) The photoresist of claim 1 wherein the photoacid-labile moiety is a polymer unit distinct from the heteroalicyclic group and of carbon alicyclic group.

- Claim 48. (previously presented) The photoresist of claim 1 wherein the polymer further comprises lactone or anhydride units.
- Claim 49. (previously presented) The photoresist of claim 1 wherein the polymer further comprises polymerized maleic anhydride groups.
- Claim 50. (previously presented) The photoresist of claim 1 wherein the heteroalicyclic group fused to the polymer backbone does not contain an unsaturated oxygen.
- Claim 51. (previously presented) The photoresist of claim 1 wherein the heteroalicyclic group fused to the polymer backbone does not contain an unsaturated sulfur.
- Claim 52. (currently amended) A photoresist comprising a photoactive component and a polymer that comprises: i) a heteroalicyclic group fused to the polymer backbone and that contains one or more oxygen ring members but does not contain an unsaturated oxygen and is not an oxynorbornyl; ii) a carbon alicyclic group fused to the polymer backbone; and iii) a photoacid-labile moiety.
- Claim 53. (previously presented) The photoresist of claim 52 wherein the carbon alicyclic group is a polymerized norbornene group.
- Claim 54. (previously presented) The photoresist of claim 52 wherein the photoacid-labile moiety is a substituent of the heteroalicyclic group or carbon alicyclic group.
- Claim 55. (currently amended) The photoresist of claim 52 wherein the photoacid-labile moiety is a polymer unit distinct from the heteroalicyclic group and of carbon alicyclic group.

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- Claim 56. (previously presented) The photoresist of claim 52 wherein the polymer further comprises lactone or anhydride units.
- Claim 57. (previously presented) The photoresist of claim 52 wherein the polymer further comprises polymerized maleic anhydride groups.
- Claim 58. (previously presented) A method of forming a positive photoresist relief image, comprising:
 - (a) applying a coating layer of a photoresist of claim 52 on a substrate; and
 - (b) exposing and developing the photoresist image to yield a relief image.
- Claim 59. (previously presented) The method of claim 58 wherein the photoresist layer is exposed with radiation having a wavelength of less than about 200 nm.
- Claim 60. (previously presented) The method of claim 58 wherein the photoresist layer is exposed with radiation having a wavelength of about 193 nm.
- Claim 61. (currently amended) The method of claim 35 + wherein the photoresist layer is exposed with radiation having a wavelength of less than about 200 nm.
- Claim 62. (currently amended) The method of claim 35 † wherein the photoresist layer is exposed with radiation having a wavelength of about 193 nm.
- Claim 63. (previously presented) An article of manufacture comprising a microelectronic wafer substrate having coated thereon a layer of the photoresist of claim 52.
- Claim 64. (new) The photoresist composition of claim 1 wherein the polymer is at least substantially free of aromatic groups.

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- Claim 65. (new) The photoresist composition of claim 1 wherein the heteroalicyclic group that is not an anhydride or lactone.
- Claim 66. (new) The photoresist composition of claim 1 wherein the heteroalicyclic group contains a single ring oxygen atom.
- Claim 67. (new) The photoresist composition of claim 52 wherein the polymer is at least substantially free of aromatic groups.
- Claim 68. (new) The photoresist composition of claim 52 wherein the heteroalicyclic group contains a single ring oxygen atom.
- Claim 69. (new) A photoresist comprising a photoactive component and a polymer that comprises: i) a heteroalicyclic group that is not an anhydride or lactone and is fused to the polymer backbone and that contains one or more oxygen or sulfur ring atoms; ii) a carbon alicyclic group fused to the polymer backbone; and iii) a photoacid-labile moiety.